

HD74HC112

Dual J-K Flip-Flops (with Preset and Clear)

REJ03D0562-0200 (Previous ADE-205-435) Rev.2.00 Oct 11, 2005

Description

Each flip-flop has independent J, K, preset, clear and clock inputs and Q and \overline{Q} outputs. This device is edge sensitive to the clock input and change state on the negative going transition of the clock pulse. Clear and preset are independent of the clock and accomplished by a low logic level on the corresponding input.

Features

• High Speed Operation: t_{pd} (Clock to Q) = 17 ns typ ($C_L = 50 \text{ pF}$)

• High Output Current: Fanout of 10 LSTTL Loads

• Wide Operating Voltage: $V_{CC} = 2 \text{ to } 6 \text{ V}$

• Low Input Current: 1 μA max

• Low Quiescent Supply Current: I_{CC} (static) = 2 μ A max (Ta = 25°C)

• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74HC112P	DILP-16 pin	PRDP0016AE-B (DP-16FV)	Р	_
HD74HC112FPEL	SOP-16 pin (JEITA)	PRSP0016DH-B (FP-16DAV)	FP	EL (2,000 pcs/reel)

Note: Please consult the sales office for the above package availability.

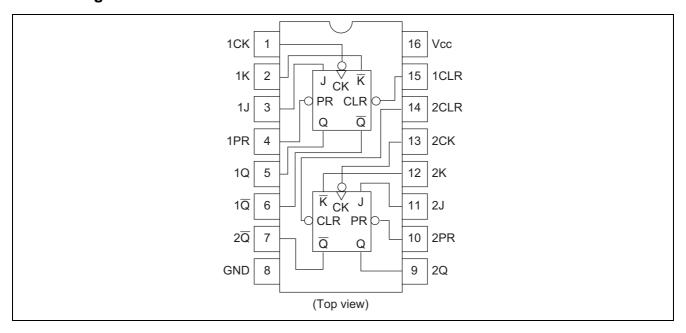
Function Table

		Inputs			Out	puts	
Preset	Clear	Clock	J	K	Q	Q	
L	Н	X	Х	X	Н	L	
Н	L	X	X	X	L	Н	
L	L	X	Х	X	H ^{*1}	H ^{*1}	
Н	Н		L	L	No change		
Н	Н		L	Н	L	Н	
Н	Н		Н	L	Н	L	
Н	Н		Н	Н	Τοί	ggle	
Н	Н	L	X	X	No ch	nange	
Н	Н	Н	X	X	No change		
Н	Н		X	Х	No ch	nange	

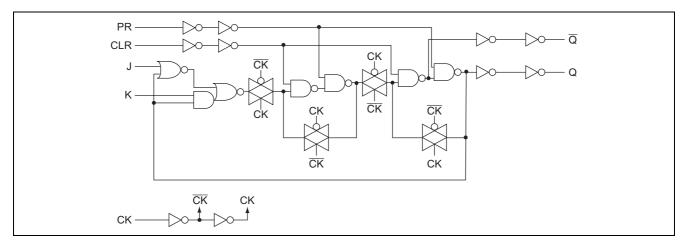
H: High levelL: Low levelX: Irrelevant

Note: 1. Q and \overline{Q} will remain High as long as Preset and Clear are Low, but Q and \overline{Q} are unpredictable, if Preset and Clear go High simultaneously.

Pin Arrangement



Logic Diagram (1/2)



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit
Supply voltage range	Vcc	-0.5 to 7.0	V
Input / Output voltage	Vin, Vout	-0.5 to V _{CC} +0.5	V
Input / Output diode current	I _{IK} , I _{OK}	±20	mA
Output current	l _o	±25	mA
V _{CC} , GND current	I _{CC} or I _{GND}	±50	mA
Power dissipation	P _T	500	mW
Storage temperature	Tstg	-65 to +150	°C

Note: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

Recommended Operating Conditions

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V _{CC}	2 to 6	V	
Input / Output voltage	V _{IN} , V _{OUT}	0 to V _{CC}	V	
Operating temperature	Та	-40 to 85	°C	
		0 to 1000		$V_{CC} = 2.0 \text{ V}$
Input rise / fall time*1	t_r, t_f	0 to 500	ns	$V_{CC} = 4.5 \text{ V}$
		0 to 400		$V_{CC} = 6.0 \text{ V}$

Note: 1. This item guarantees maximum limit when one input switches. Waveform: Refer to test circuit of switching characteristics.

Electrical Characteristics

			Т	a = 25°	С	Ta = -40	to+85°C			
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Cor	nditions
Input voltage	V _{IH}	2.0	1.5	_	_	1.5	_	V		
		4.5	3.15	_	_	3.15	_			
		6.0	4.2		_	4.2	_			
	V _{IL}	2.0	_	_	0.5	_	0.5	V		
		4.5	_	_	1.35	_	1.35			
		6.0	_		1.8	_	1.8			
Output voltage	V _{OH}	2.0	1.9	2.0	_	1.9	_	V	$Vin = V_{IH} or V_{IL}$	$I_{OH} = -20 \mu A$
		4.5	4.4	4.5	_	4.4	_			
		6.0	5.9	6.0	_	5.9	_			
		4.5	4.18	_	_	4.13	_			$I_{OH} = -4 \text{ mA}$
		6.0	5.68	_	_	5.63	_			$I_{OH} = -5.2 \text{ mA}$
	V_{OL}	2.0	1	0.0	0.1		0.1	V	$Vin = V_{IH} \text{ or } V_{IL}$	$I_{OL} = 20 \mu A$
		4.5	_	0.0	0.1	_	0.1			
		6.0	_	0.0	0.1		0.1			
		4.5	_	_	0.26	_	0.33			$I_{OL} = 4 \text{ mA}$
		6.0	_	_	0.26	_	0.33			$I_{OL} = 5.2 \text{ mA}$
Input current	lin	6.0	_	_	±0.1	_	±1.0	μΑ	Vin = V _{CC} or GND	
Quiescent supply current	I _{CC}	6.0	_	_	2.0	_	20	μΑ	$Vin = V_{CC}$ or GN	ID, lout = $0 \mu A$

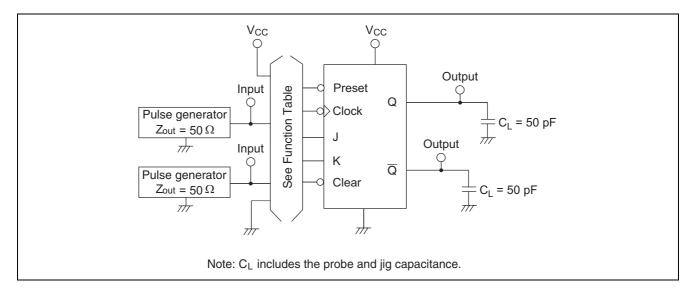
Switching Characteristics ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$)

			Ta = 25°C		Ta = -40 to +85°C				
Item	Symbol	V _{CC} (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Maximum clock	f _{max}	2.0	_	_	6	_	5	MHz	
frequency		4.5			30	_	24		
		6.0			35	_	28		
Propagation delay	t_{PLH} , t_{PHL}	2.0		_	150	_	190	ns	Clock to Q or Q
time		4.5		17	30	_	38		
		6.0			26	_	33		
		2.0			140	_	175	ns	Clear to Q or Q
		4.5		15	28	_	35		
		6.0			24	_	30		
		2.0		_	140	_	175	ns	Preset to Q or \overline{Q}
		4.5	_	16	28	_	35		
		6.0	_	_	24	_	30		

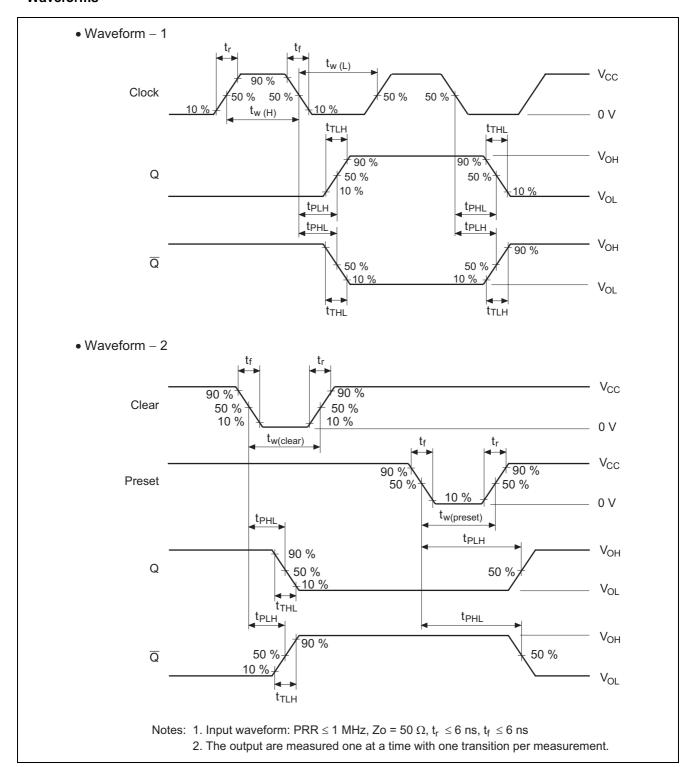
Switching Characteristics ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$)

			Т	a = 25°	С	Ta = -40	to +85°C		
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Pulse width	t _w	2.0	80	_	_	100	_	ns	Clear, Clock
		4.5	16	9	_	20	_		
		6.0	14	_	_	17	_		
Setup time	t _{su}	2.0	100	_	_	125	_	ns	J or K to Clock
		4.5	20	3	_	25	_		
		6.0	17		_	21	_		
Hold time	t _h	2.0	5	_	_	5	_	ns	Clock to J or K
		4.5	5	-2	_	5			
		6.0	5	_	_	5	_		
Removal time	t _{rem}	2.0	100		_	125	_	ns	Clear to Clock
		4.5	20	2	_	25	_		
		6.0	17		_	21	_		
Output rise/fall	t _{TLH} , t _{THL}	2.0	_	_	75	_	95	ns	
time		4.5	_	5	15	_	19		
		6.0	_	_	13	_	16		
Input capacitance	Cin	_	_	5	10	_	10	pF	

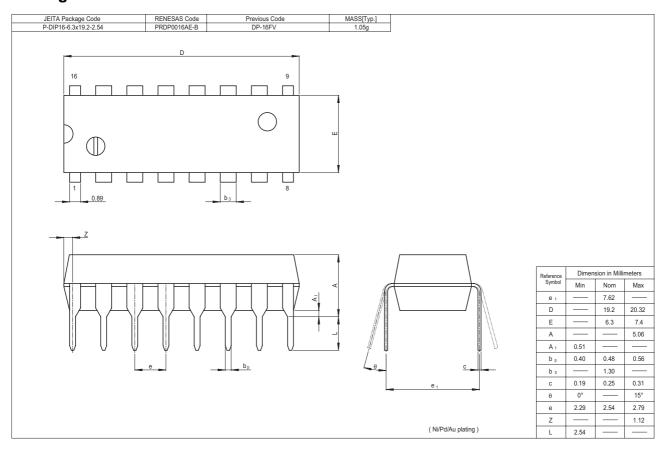
Test Circuit

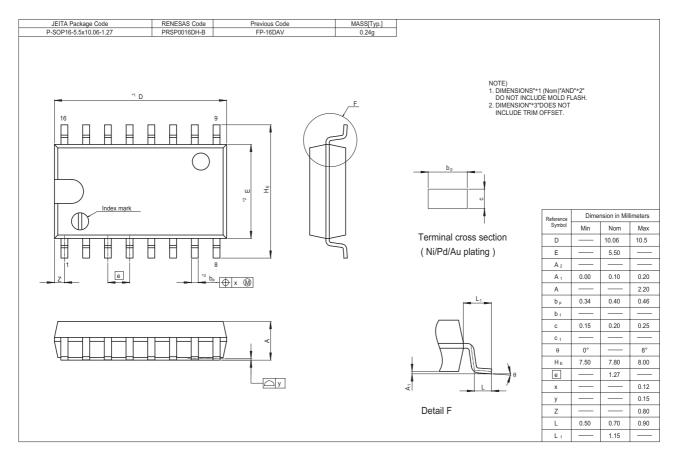


Waveforms



Package Dimensions





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